2 - 1571586 - 2 Product Details

Live Product Chat US Only
8:30am - 5pm ET, Mon - Fri

2 - 1571586 - 2
(808 - AG11D - LF)
✔ Active

DIP Sockets

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:
- DIP Socket
- Number of Positions = 8
- Row - to - Row Spacing = 7.62 mm
- Thru Hole
- Mount Style = Vertical

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Documentation & Additional Information

Product Drawings:
- OPEN FRAME DIP, PREMIUM (MACHINE CONTACT), LEAD FR... (PDF, English)

Catalog Pages/Data Sheets:
- None Available

Product Specifications:
- None Available

Application Specifications:
- None Available

Instruction Sheets:
- None Available

CAD Files:
- None Available

Additional Information:
- Product Line Information

Related Products:
- Tooling

List all Documents

Product Features   (Please use the Product Drawing for all design activity)

Product Type Features:
- Product Type = DIP Socket
- Number of Positions = 8
- Profile = Standard
- Frame Style = Ladder
- Leg Style = Straight
- Sleeve Material = Copper
- Product Series = 800 Series

Electrical Characteristics:
- Insulation Resistance (M?) = 5,000
- Contact Resistance (m?) = 10

Termination Related Features:
- Termination (Solder) Post Length (mm [in]) = 3.18 [0.125]
- Solder Tail Contact Plating = Tin

Body Related Features:
- Row - to - Row Spacing (mm [in]) = 7.62 [0.300]
- Mount Style = Vertical
- Centerline (mm [in]) = 2.54 [0.100]

Contact Related Features:
- Contact Mount = Thru Hole
- Contact Material = Beryllium Copper
- Contact Mating Area Plating Material = Gold (25)
- Contact Style = Screw Machine
- Mating Contact Type = Four - Fingered

Housing Related Features:
- Housing Material = Thermoplastic Polyester
- Housing Flammability Rating = UL 94V -0

Configuration Related Features:
- Height Above PC Board (mm [in]) = 2.67 [0.105]

Industry Standards:
- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Wave solder capable to 240°C, Wave solder capable to 260°C, Wave solder capable to 265°C
- RoHS/ELV Compliance History = Always was RoHS compliant

Conditions for Usage:
- Temperature Range (°C) = -55 − + 105

Packaging Related Features:
- Packaging Method = Tube

Other:
- Brand = Tyco Electronics